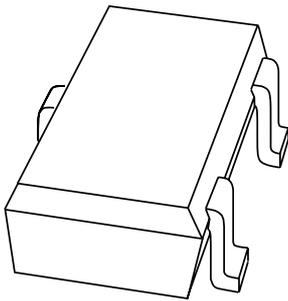


# DATA SHEET



**BFS540**

**NPN 9 GHz wideband transistor**

Product specification  
Supersedes data of 1997 Dec 05

2000 May 30

# NPN 9 GHz wideband transistor

# BFS540

## FEATURES

- High power gain
- Low noise figure
- High transition frequency
- Gold metallization ensures excellent reliability
- SOT323 package.

## APPLICATIONS

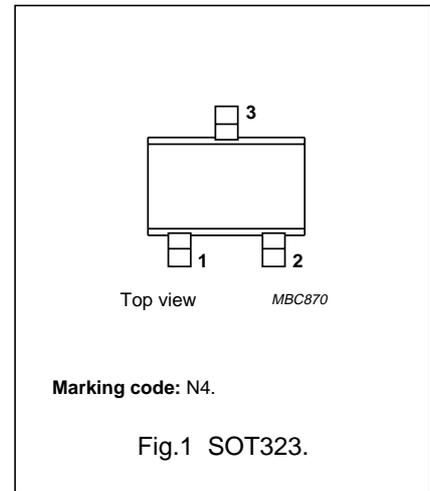
RF wideband amplifier applications such as satellite TV systems and RF portable communication equipment with signal frequencies up to 2 GHz.

## DESCRIPTION

NPN transistor in a SOT323 plastic package.

## PINNING

PIN	DESCRIPTION
1	base
2	emitter
3	collector



## QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	–	–	20	V
$V_{CEO}$	collector-emitter voltage	open base	–	–	15	V
$I_C$	DC collector current		–	–	120	mA
$P_{tot}$	total power dissipation	$T_s \leq 80\text{ }^\circ\text{C}$ ; note 1	–	–	500	mW
$h_{FE}$	DC current gain	$I_C = 40\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $T_j = 25\text{ }^\circ\text{C}$	100	120	250	
$f_T$	transition frequency	$I_C = 40\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $f = 1\text{ GHz}$ ; $T_{amb} = 25\text{ }^\circ\text{C}$	–	9	–	GHz
$G_{UM}$	maximum unilateral power gain	$I_C = 40\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $f = 900\text{ MHz}$ ; $T_{amb} = 25\text{ }^\circ\text{C}$	–	14	–	dB
F	noise figure	$I_C = 10\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $f = 900\text{ MHz}$ ; $T_{amb} = 25\text{ }^\circ\text{C}$	–	1.3	1.7	dB

### Note

1.  $T_s$  is the temperature at the soldering point of the collector tab.

## LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	–	20	V
$V_{CES}$	collector-emitter voltage	$R_{BE} = 0$	–	15	V
$V_{EBO}$	emitter-base voltage	open collector	–	2.5	V
$I_C$	DC collector current		–	120	mA
$P_{tot}$	total power dissipation	$T_s \leq 80\text{ }^\circ\text{C}$ ; note 1	–	500	mW
$T_{stg}$	storage temperature		–65	150	$^\circ\text{C}$
$T_j$	junction temperature		–	175	$^\circ\text{C}$

### Note

1.  $T_s$  is the temperature at the soldering point of the collector tab.

## NPN 9 GHz wideband transistor

## BFS540

## THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-s}$	thermal resistance from junction to soldering point	$T_s \leq 80\text{ °C}$ ; note 1	190	K/W

## Note

- $T_s$  is the temperature at the soldering point of the collector tab.

## CHARACTERISTICS

$T_j = 25\text{ °C}$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_{CBO}$	collector cut-off current	$I_E = 0$ ; $V_{CE} = 8\text{ V}$	–	–	50	nA
$h_{FE}$	DC current gain	$I_C = 40\text{ mA}$ ; $V_{CE} = 8\text{ V}$	100	120	250	
$C_e$	emitter capacitance	$I_C = i_c = 0$ ; $V_{EB} = 0.5\text{ V}$ ; $f = 1\text{ MHz}$	–	2	–	pF
$C_c$	collector capacitance	$I_E = i_e = 0$ ; $V_{CB} = 8\text{ V}$ ; $f = 1\text{ MHz}$	–	0.9	–	pF
$C_{re}$	feedback capacitance	$I_C = 0$ ; $V_{CB} = 8\text{ V}$ ; $f = 1\text{ MHz}$	–	0.6	–	pF
$f_T$	transition frequency	$I_C = 40\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $f = 1\text{ GHz}$ ; $T_{amb} = 25\text{ °C}$	–	9	–	GHz
$G_{UM}$	maximum unilateral power gain (note 1)	$I_C = 40\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $f = 900\text{ MHz}$ ; $T_{amb} = 25\text{ °C}$	–	14	–	dB
		$I_C = 40\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $f = 2\text{ GHz}$ ; $T_{amb} = 25\text{ °C}$	–	8	–	dB
$ S_{21} ^2$	insertion power gain	$I_C = 40\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $f = 900\text{ MHz}$ ; $T_{amb} = 25\text{ °C}$	12	13	–	dB
F	noise figure	$\Gamma_s = \Gamma_{opt}$ ; $I_C = 10\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $f = 900\text{ MHz}$ ; $T_{amb} = 25\text{ °C}$	–	1.3	1.8	dB
		$\Gamma_s = \Gamma_{opt}$ ; $I_C = 40\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $f = 900\text{ MHz}$ ; $T_{amb} = 25\text{ °C}$	–	1.9	2.4	dB
		$\Gamma_s = \Gamma_{opt}$ ; $I_C = 10\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $f = 2\text{ GHz}$ ; $T_{amb} = 25\text{ °C}$	–	2.1	–	dB
$P_{L1}$	output power at 1 dB gain compression	$I_C = 40\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $R_L = 50\text{ }\Omega$ ; $f = 900\text{ MHz}$ ; $T_{amb} = 25\text{ °C}$	–	21	–	dBm
ITO	third order intercept point	note 2	–	34	–	dBm

## Notes

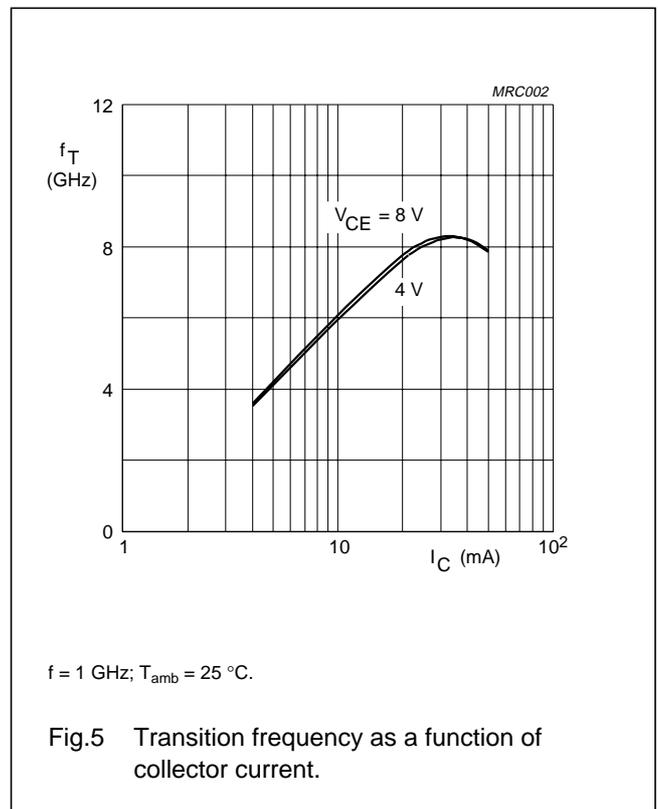
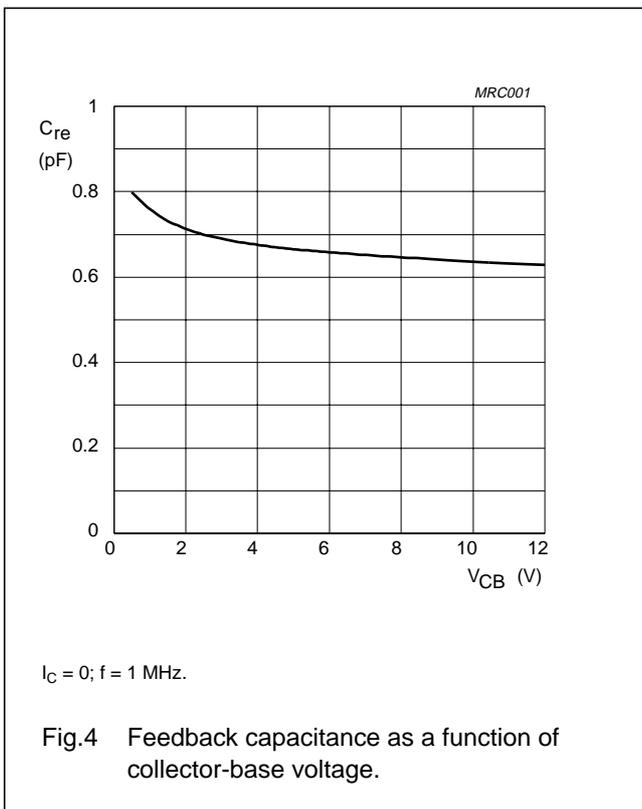
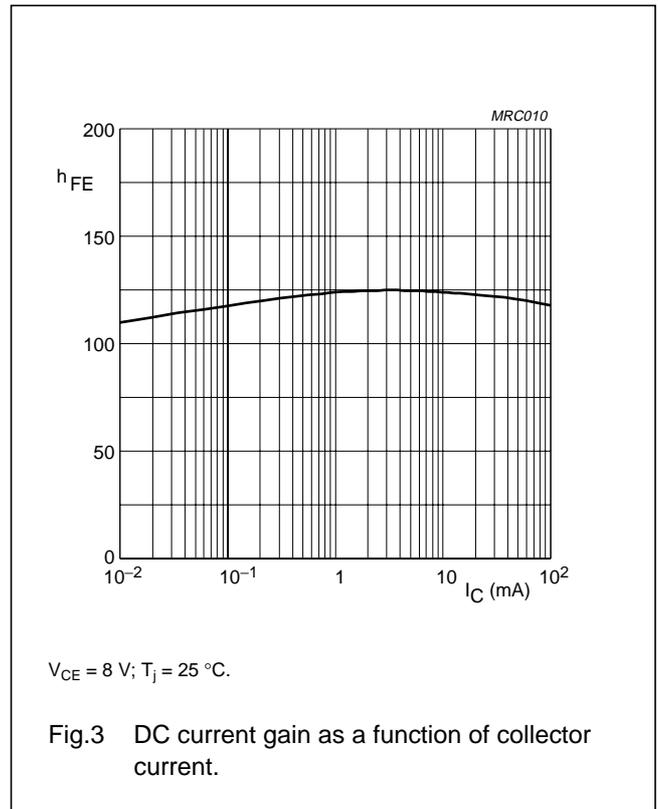
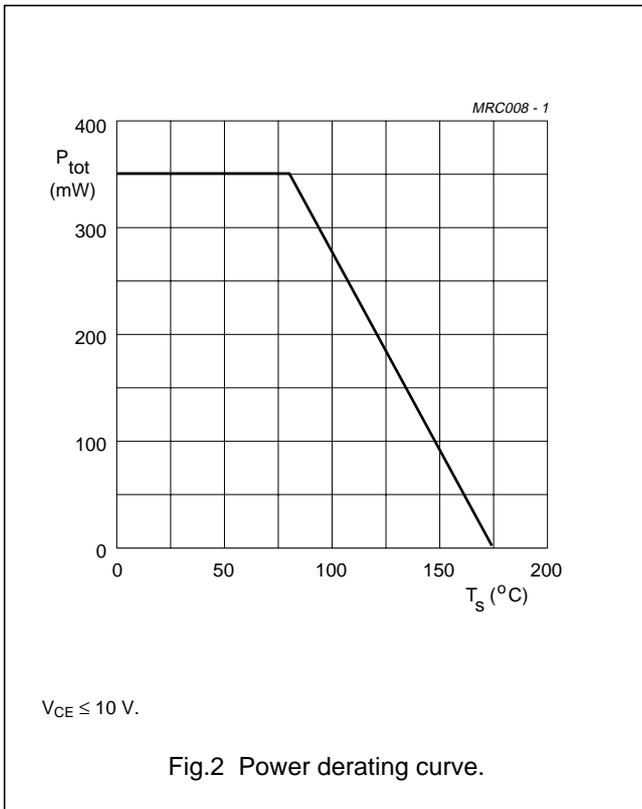
- $G_{UM}$  is the maximum unilateral power gain, assuming  $s_{12}$  is zero and

$$G_{UM} = 10 \log \frac{|s_{21}|^2}{(1 - |s_{11}|^2)(1 - |s_{22}|^2)} \text{ dB.}$$

- $I_C = 40\text{ mA}$ ;  $V_{CE} = 8\text{ V}$ ;  $R_L = 50\text{ }\Omega$ ;  $f = 900\text{ MHz}$ ;  $T_{amb} = 25\text{ °C}$ ;  
 $f_p = 900\text{ MHz}$ ;  $f_q = 902\text{ MHz}$ ; measured at  $f_{(2p-q)} = 898\text{ MHz}$  and at  $f_{(2q-p)} = 904\text{ MHz}$ .

NPN 9 GHz wideband transistor

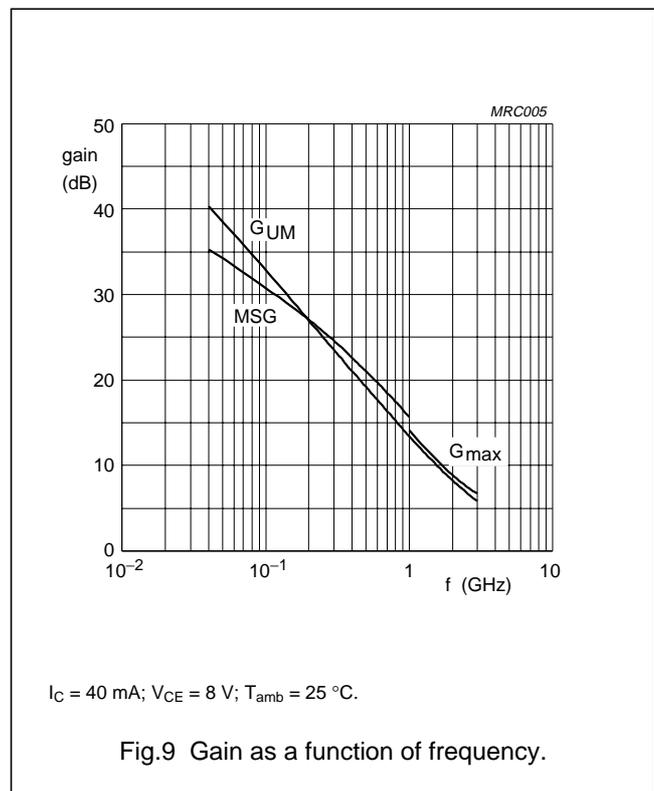
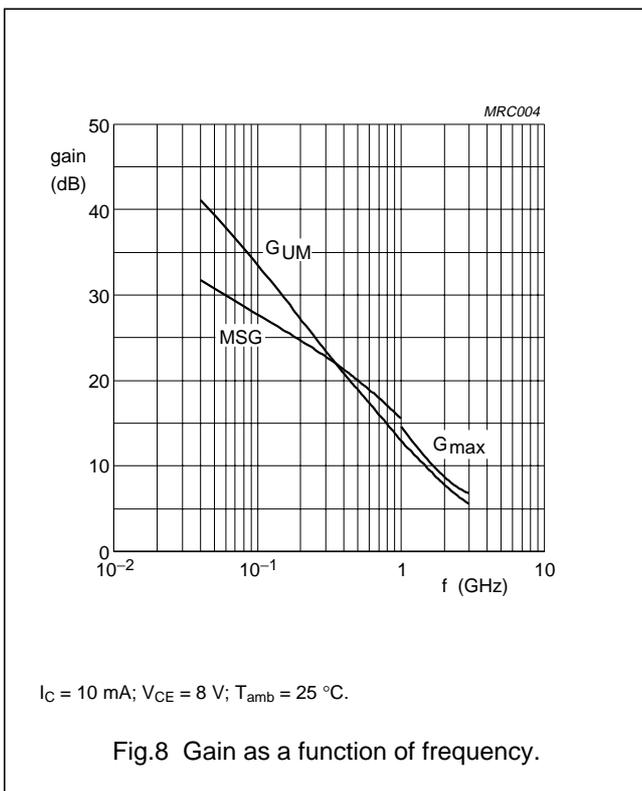
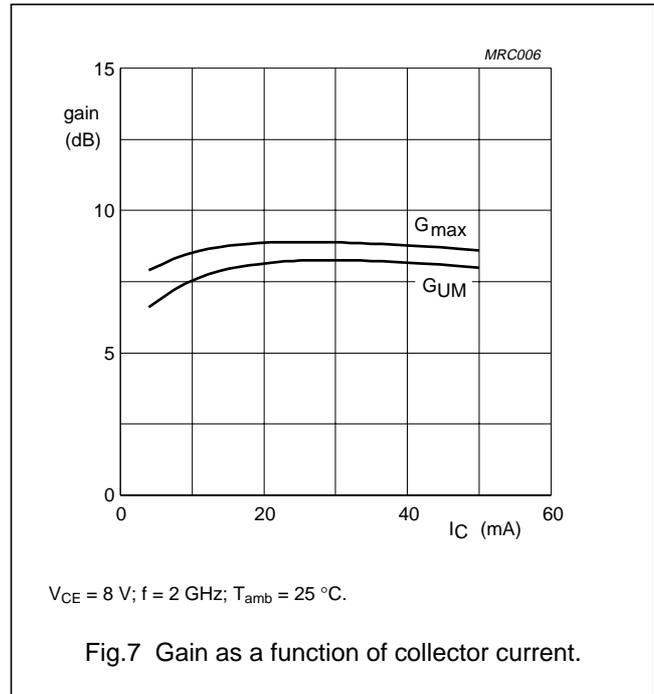
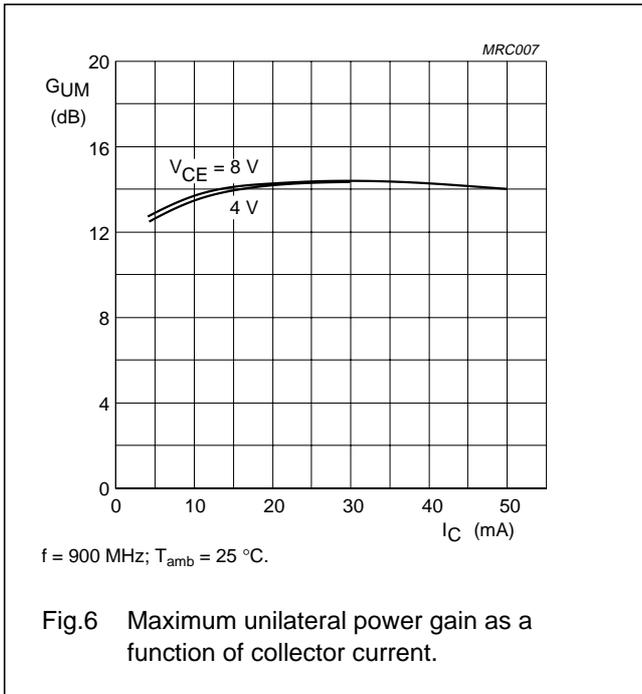
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NPN 9 GHz wideband transistor

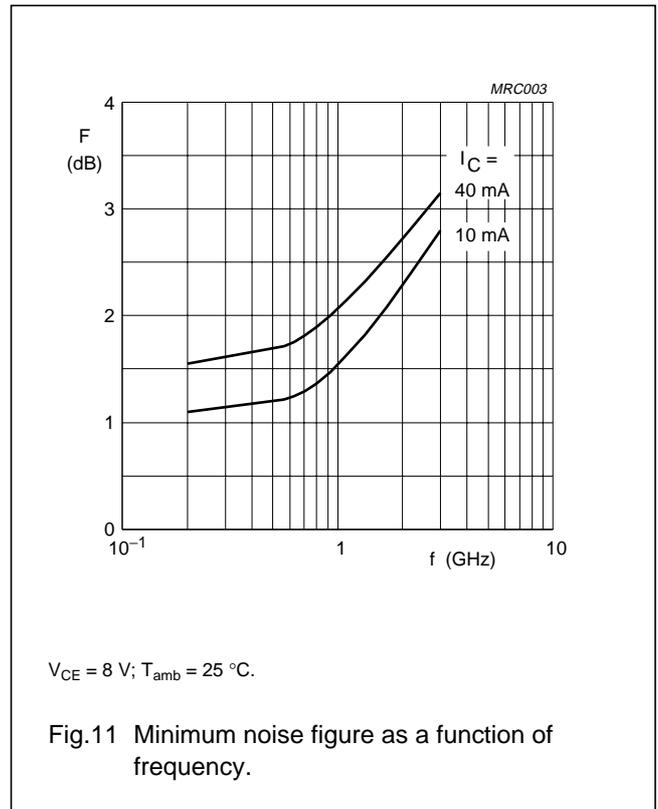
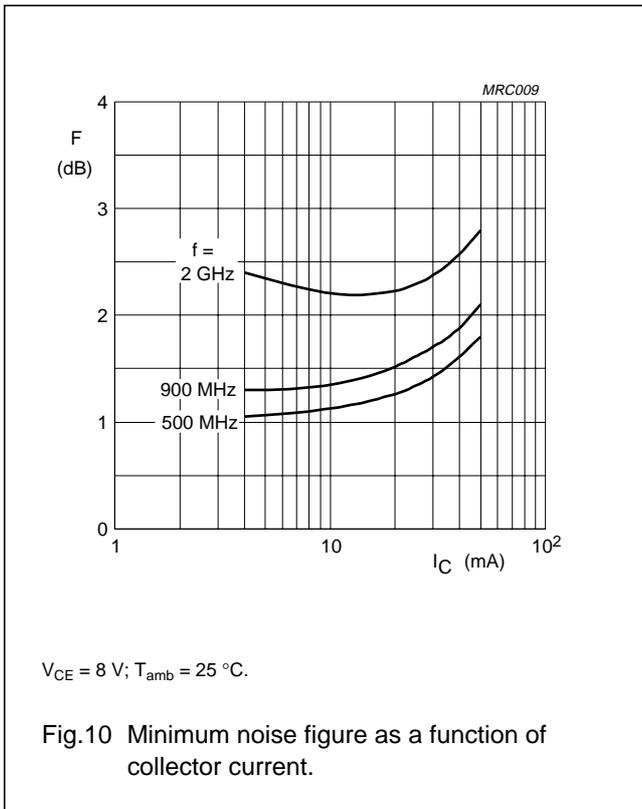
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In Figs 6 to 9,  $G_{UM}$  = maximum unilateral power gain;  $MSG$  = maximum stable gain;  $G_{max}$  = maximum available gain.



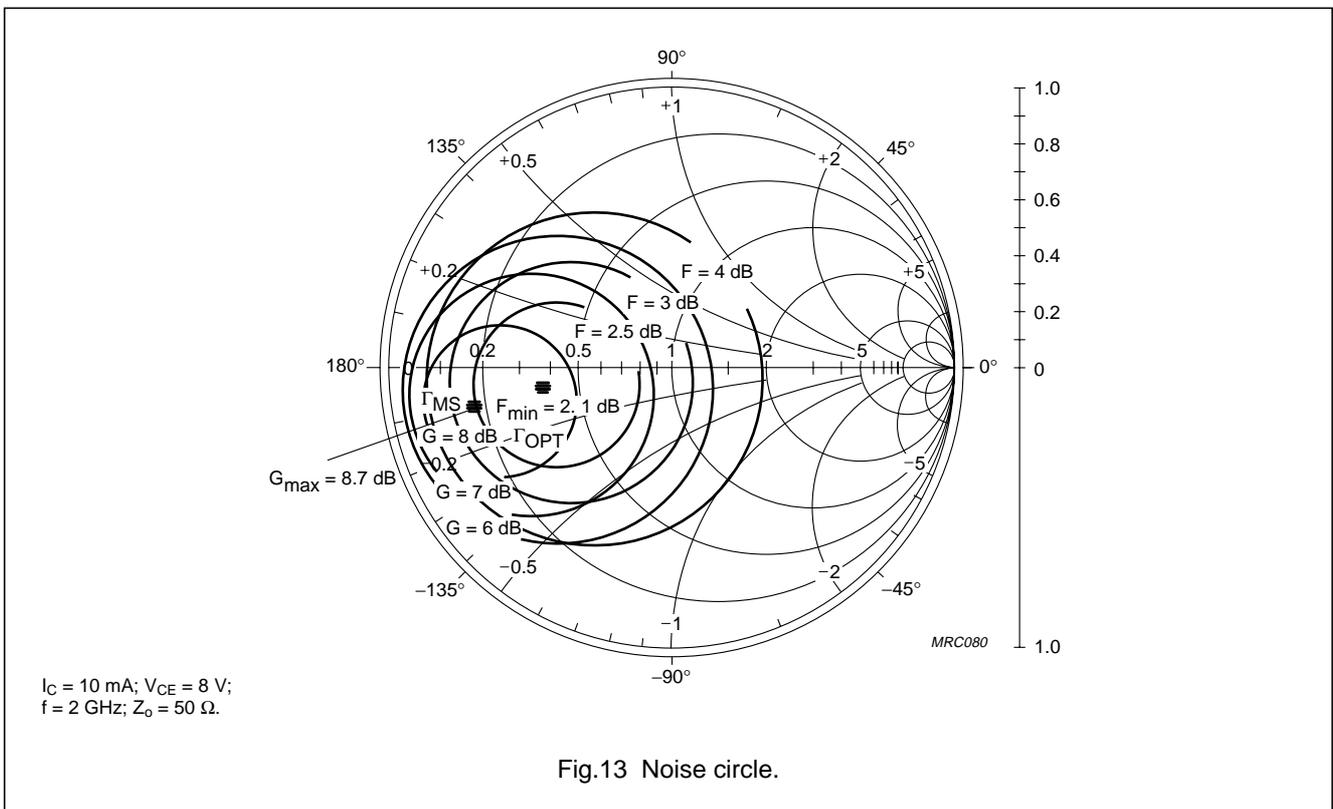
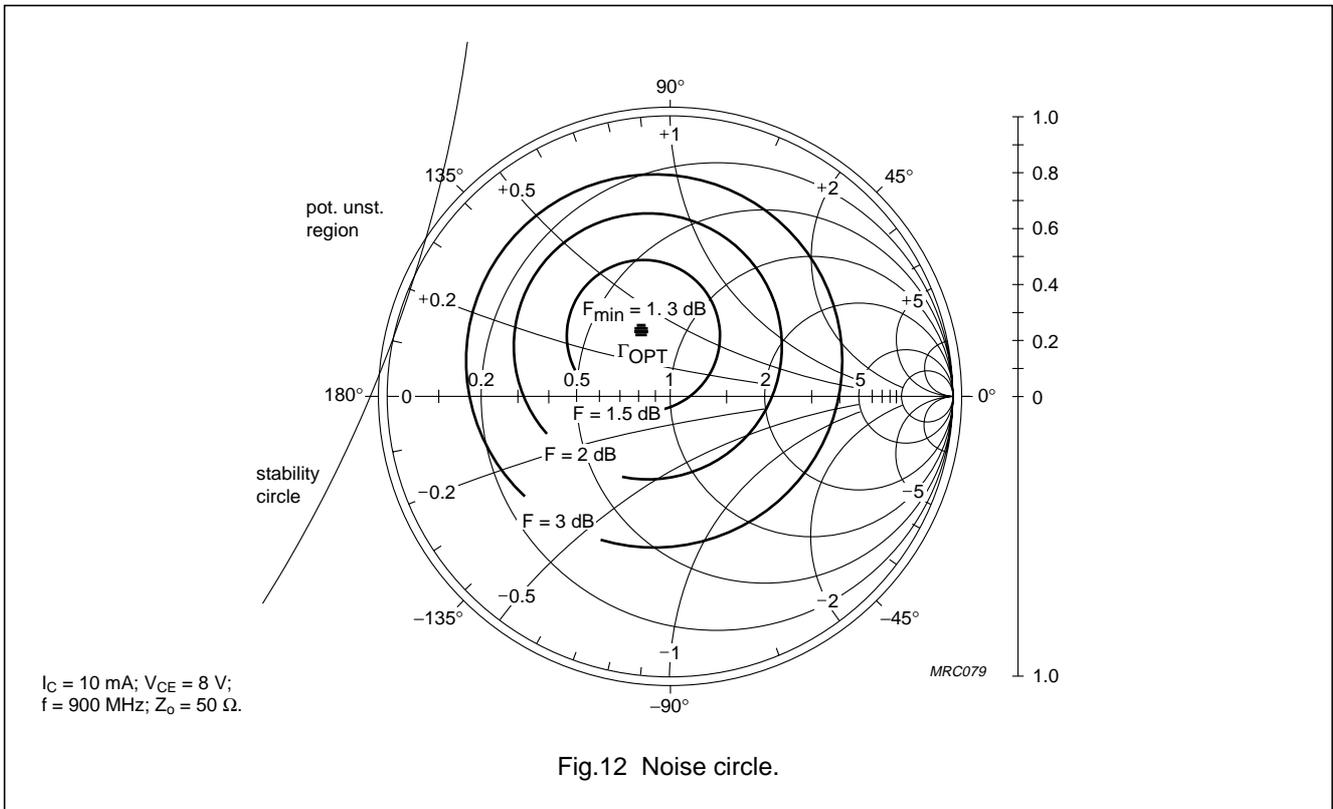
NPN 9 GHz wideband transistor

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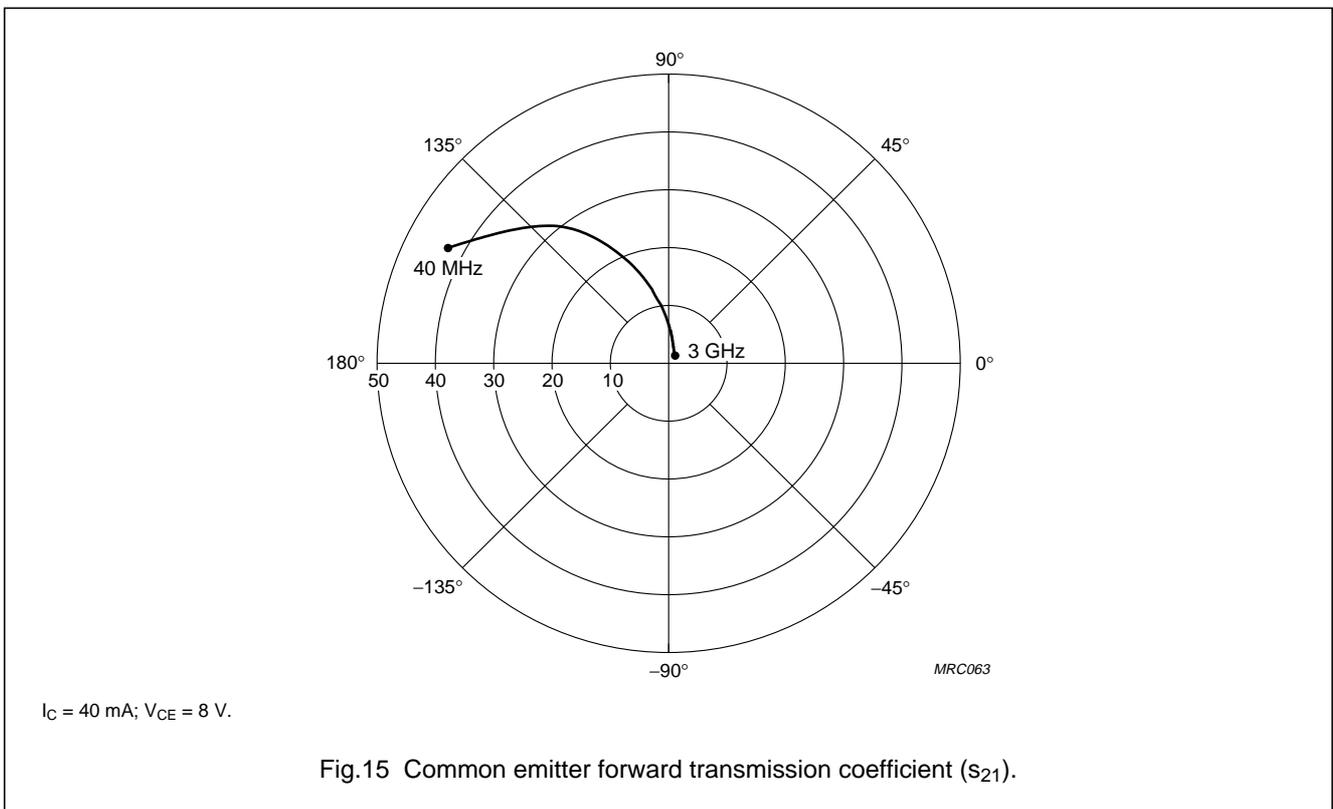
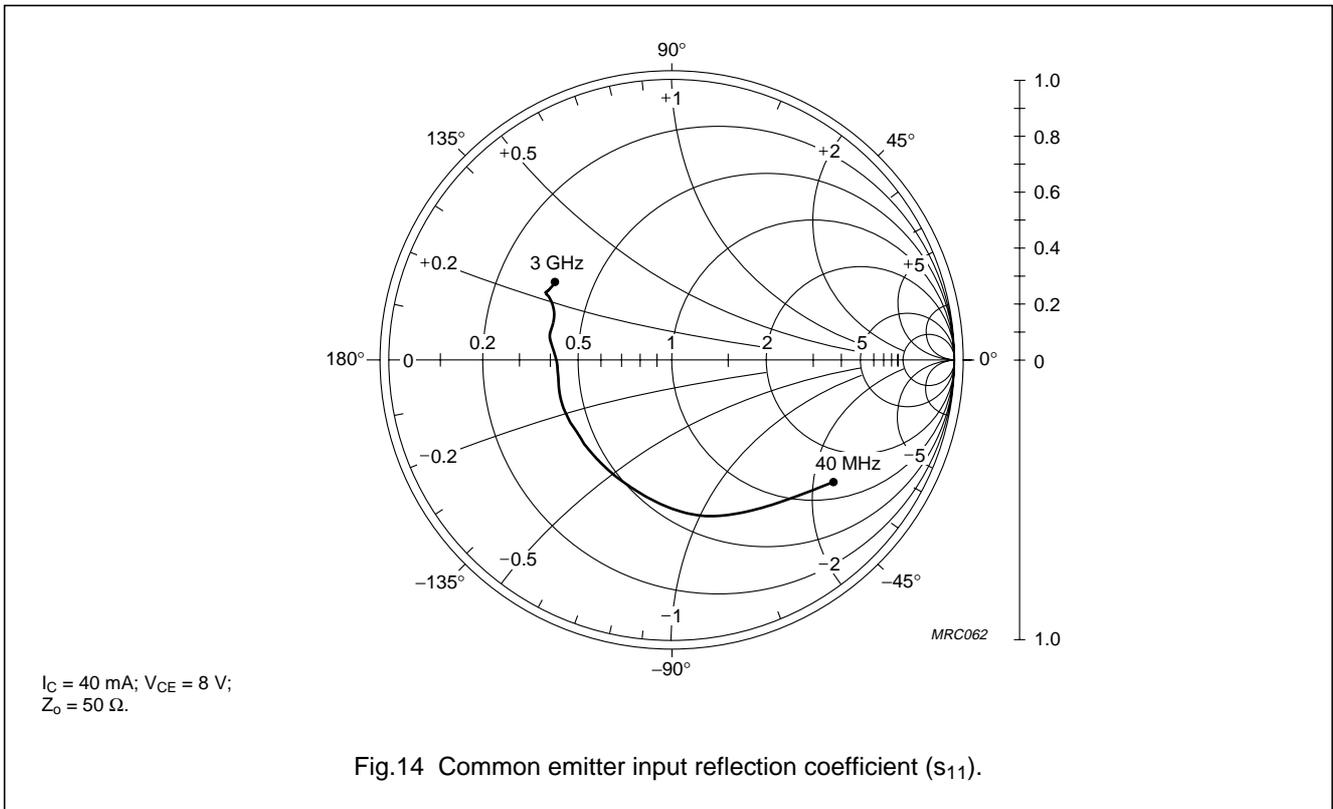
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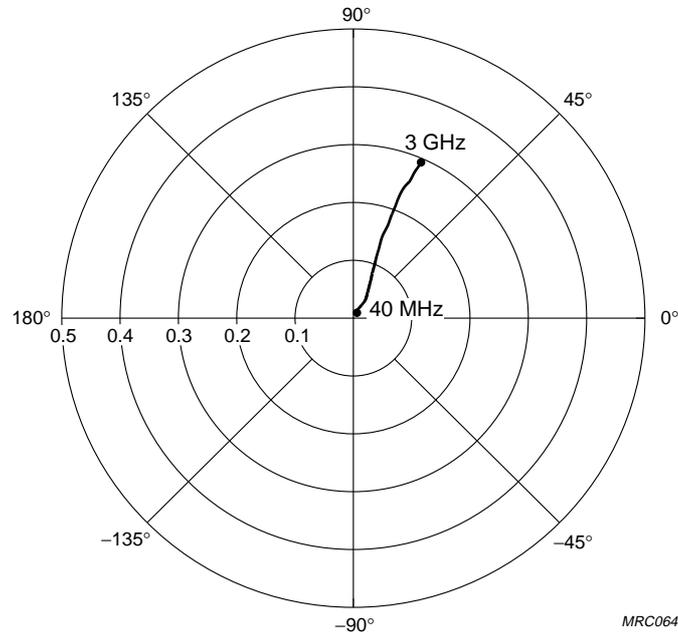
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NPN 9 GHz wideband transistor

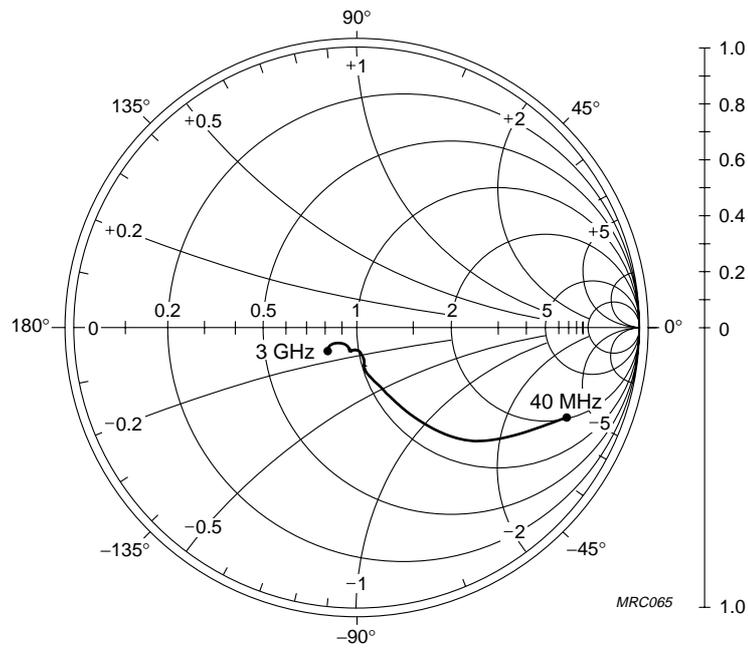
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$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}.$

MRC064

Fig.16 Common emitter reverse transmission coefficient ( $s_{12}$ ).



$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V};$   
 $Z_o = 50 \Omega.$

MRC065

Fig.17 Common emitter output reflection coefficient ( $s_{22}$ ).

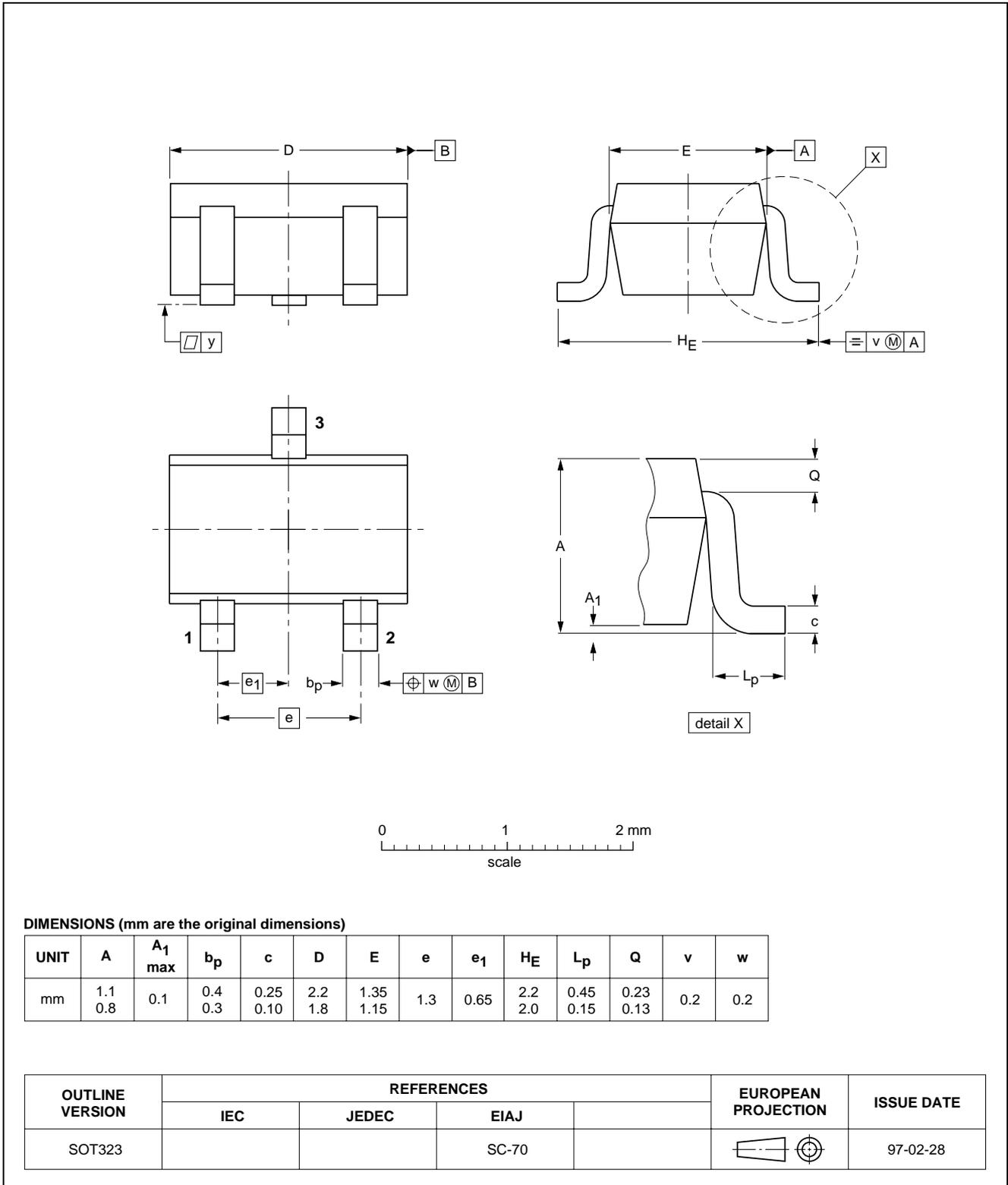
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PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT323



NPN 9 GHz wideband transistor

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DATA SHEET STATUS	PRODUCT STATUS	DEFINITIONS <sup>(1)</sup>
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